

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2629713

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	RELEASE BY SECURED PARTY
CONVEYING PARTY DATA	
Name	Execution Date
GOLD HILL CAPITAL 2008, LP	10/01/2013
RECEIVING PARTY DATA	
Name:	SENDMAIL, INC.
Street Address:	6475 CHRISTIE AVE
Internal Address:	SUITE 350
City:	EMMERYVILLE
State/Country:	CALIFORNIA
Postal Code:	94608
PROPERTY NUMBERS Total: 7	
Property Type	Number
Patent Number:	6658454
Patent Number:	6865671
Patent Number:	6986037
Patent Number:	7058687
Patent Number:	7117246
Patent Number:	7146402
Patent Number:	8095677
CORRESPONDENCE DATA	
Fax Number:	(408)517-4711
Phone:	408-517-4710
Email:	mlemley@proofpoint.com
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>	
Correspondent Name:	MICHAEL LEMLEY
Address Line 1:	982 ROSS DRIVE
Address Line 4:	SUNNYVALE, CALIFORNIA 94089

OP \$280.00 6658454

NAME OF SUBMITTER:	MICHAEL S LEMLEY
Signature:	/s Michael S Lemley s/
Date:	11/26/2013
Total Attachments: 3 source=GOLD HILL CAP-Release of Security Interest#page1.tif source=GOLD HILL CAP-Release of Security Interest#page2.tif source=GOLD HILL CAP-Release of Security Interest#page3.tif	

RELEASE OF SECURITY INTEREST

This Release of Security Interest is made effective as of October 1, 2013 (this "Release"), by Gold Hill Capital 2008, LP ("Lender") in favor of SENDMAIL, INC., a Delaware corporation ("Company") with its principal place of business located at 6475 Christie Avenue, Suite 350, Emeryville, CA 94608.

RECITAL

WHEREAS Company and Lender entered into a Loan and Security Agreement dated as of January 31, 2013 as may have been amended, modified, or otherwise supplemented from time to time (the "Loan Agreement").

WHEREAS, in connection with the Loan Agreement, Company granted to Lender a security interest in the patents and trademarks set forth on Exhibits A and B, respectively, attached hereto (collectively, the "Intellectual Property") under an Intellectual Property Security Agreement dated as of January 31, 2013 (the "Security Agreement") and recorded with the U.S. Patent and Trademark Office in the patent assignments branch at Reel/Frame 029745/0107 and in the trademark assignments branch at Reel/Frame 4955/0001.

WHEREAS, pursuant to that certain Payoff Agreement dated as of October 1, 2013 by and between Lender and Company, Company has no outstanding obligations to Lender under the Loan Agreement or under the Security Agreement, and therefore Lender agrees to release its security interest in the Intellectual Property.

AGREEMENT

Now therefore, Lender agrees that it terminates and releases its security interest in the Intellectual Property and reassigns to Company, without warranty or recourse, all interest of Lender in the Intellectual Property.

LENDER: GOLD HILL CAPITAL 2008, LP

By:  _____

Name (print): Sean Lynden

Title: Partner

Title: Gold Hill Capital

Gold Hill Capital 2008, LP
One Almaden Blvd., Suite 630
San Jose, CA 95113

EXHIBIT A

Patents

Title	Patent No.	Grant Date
Electronic Mail System With Improved Methodology For Processing Messages With Mailing Lists	6,658,454	2-Dec-2003
Electronic Mail System with Authentication Methodology for Supporting Relaying In a Message Transfer Agent	6,865,671	8-Mar-2005
Electronic Mail System with Authentication/Encryption Methodology for Allowing Connections To/From a Message Transfer Agent	6,986,037	10-Jan-2006
E-Mail System with Methodology for Accelerating Mass Mailings	7,058,687	6-Jun-2006
Electronic Mail System with Methodology Providing Distributed Message Store	7,117,246	3-Oct-2006
E-Mail System Providing Filtering Methodology on a Per-Domain Basis	7,146,402	5-Dec-2006
Configuration Rule Generation with Compressed Address Sets	8,095,677	10-Jan-2012

EXHIBIT B

Trademarks

Mark	Registration No.	Registration Date	Serial No.
SENDMAIL	2407602	28 Nov 2000	75/449819
SENDMAIL	2410896	5 Dec 2000	75/979292
SENDMAIL SENTRION	3720084	1 Dec 2009	78/661296